

Product Change Notification / BLAS-18YLUC092

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19-Apr-2023

Product Category:

Memory

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6206 and 2743.002 Final Notice: Qualification of MTAI as an additional assembly site and test location for selected AT25256Bxx, AT24C512xx, AT24CM01xx, and AT25M01xx device families available in 8L SOIJ (.208in) package.

Affected CPNs:

BLAS-18YLUC092_Affected_CPN_04192023.pdf BLAS-18YLUC092_Affected_CPN_04192023.csv

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of MTAI as an additional assembly site and test location for selected AT25256Bxx, AT24C512xx, AT24CM01xx, and AT25M01xx device families available in 8L SOIJ (.208in) package.

Pre and Post Change Summary:

Note: Separate PCN was issued to qualify MTAI for CPNs AT24C512C-SHD-B,

AT24C512C-SHD-T, LIAL-27KKIA306	AT24C512C-	SHM-B, A	T24C512	C-SHM-T. R	efer to PCN #			
LIAL 27 MM/1300	Pre Ch	ange	Post Change					
Assembly Site	Amkor Technology Philippine (P1/P2), INC. (ANAP)		Tech Phi (P1/F	mkor nnology lippine P2), INC.	Microchip Technology Thailand (HQ) (MTAI)			
Wire material	Cu	PdCu	Cu	PdCu	Au			
Die attach material	8290		8290		8390A			
Molding compound material	G70	OA.	G	700A	G600V			
Lead frame material	CDA1	194	CDA194		CDA194			
DAP surface plating	PP	F	PPF		Bare Cu			
Lead frame plating	NiPd	Au	NiPdAu		Matte tin			
Lead frame	128 x 16			164 mils	140 x 160 mils			
paddle size	See	attached	pre and	e and post change comparison				

Note: This	applies to all CPN:	s listed in the Affecte	d CPN list.							
		Pre Change	Post	t Change						
Fin	al Test Site	Amkor Technology Philippine (P1/P2), INC. (ANAP)	Amkor Technology Philippine (P1/P2), INC. (ANAP)	Microchip Technology Thailand (HQ) (MTAI)						
	BQM	2000	2000	2000						
	Pin 1 Orientation	Quadrant 1	Quadrant 1	Quadrant 1						
	Carrier Tape	Minor dimension change. See pre and post change for comparison.								
Tape and	Cover Tape	Minor dimension change. See pre and post change for comparison.								
Reel	Diantia Dani	White	White	Dark Blue						
	Plastic Reel	Minor dimension change. See pre and post change for comparison.								
	Packing Static	Gray	Gray	Transparent						
	Sensitive Bag	With dimension change. See pre and post change for comparison.								
	Packing Method	See pre and post change for comparison.								
Tube	Pin 1 Orientation	See	pre and post change for	comparison.						

В	BQM	95	95	95					
С	Color	Green	Green	White					
Т	Tube	Minor dimension	Minor dimension change. See pre and post change for comparison.						
Р	Packing Method	See pre and post change for comparison.							

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve manufacturability and on-time delivery performance by qualifying MTAI as an additional assembly site and additional test location.

Change Implementation Status:In Progress

Estimated First Ship Date:June 1, 2023 (date code: 2322)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	April 2023					>	June 2023				
Workweek	1	1 4	1 5	1 6	1 7		2 2	2	2 4	2 5	2 6
Qual Report Availability				Χ							
Final PCN Issue Date				Χ							
Estimated Implementation Date							Χ				

Method to Identify Change:Traceability code

Qualification Report: Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: April 19, 2023: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_BLAS-18YLUC092_Pre and Post Change_Summary.pdf PCN_BLAS-18YLUC092_Test_Qual_Report_Summary.pdf PCN_BLAS-18YLUC092_Assembly_Qual_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

AT25256B-SHL-B

AT25256B-SHL-T

AT24C512C-SHM-B

AT24C512C-SHD-B

AT24C512C-SHM-T

AT24C512C-SHD-T

AT24CM01-SHD-B

AT24CM01-SHM-B

AT24CM01-SHD-T

AT24CM01-SHM-T

AT25M01-SHM-B

AT25M01-SHM-T

Date: Tuesday, April 18, 2023